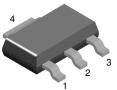


SEMICONDUCTOR

BCP51

PNP General Purpose Amplifier

- This device is designed for general purpose medium power amplifiers and switches requiring collecor currents to 1.0A.
- Sourced from process 77.



SOT-223

BCP51

1. Base 2. Collector 3. Emitter

Absolute Maximum Ratings* $T_a=25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-45	V
V _{CBO}	Collector-Base Voltage	-45	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
С	Collector Current - Continuous	-1.5	Α
Г _Ј , Т _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C
	iting values above whitch the serviceability of any semiconductor device may be impaird.		

NOTES:1. These ratings are based on a maximum junction temperature of 150 degrees C.2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

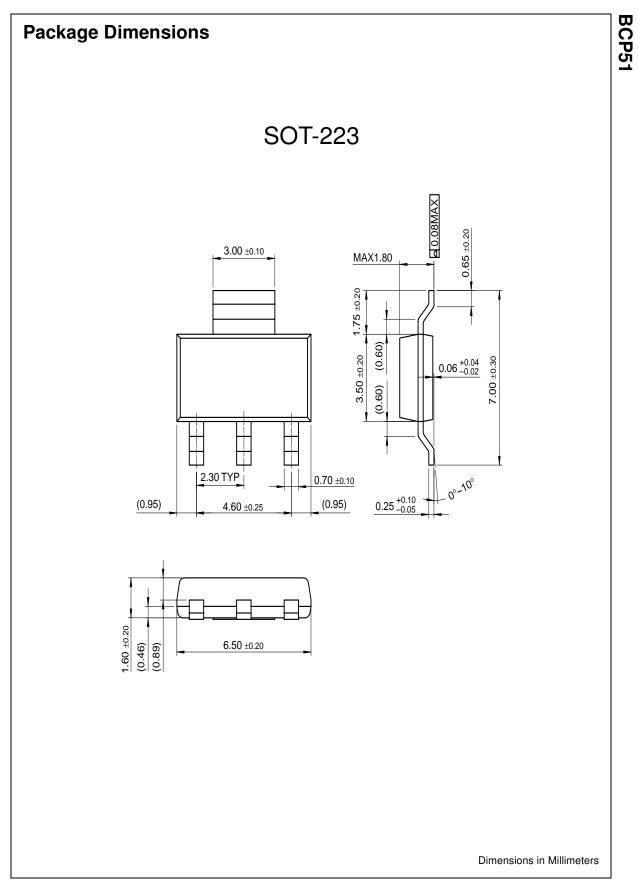
Electrical Characteristics Ta=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics	·	•	•	
V _{(BR)CEO}	Collector-Emitter Sustaining Voltage	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	-45		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = -100 \mu A, I_{\rm E} = 0$	-45		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{E} = -10\mu A, I_{C} = 0$	-5.0		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = -30V, I_E = 0$ $V_{CB} = -30V, I_E = 0, T_a = 125^{\circ}C$		-100 -10	nA μA
I _{EBO}	Emitter Cut-off Current	$V_{\rm EB} = -5.0$ V, $I_{\rm C} = 0$		-10	μA
On Characte	eristics	·	•	•	
h _{FE}	DC Current Gain	$I_{C} = -5.0$ mA, $V_{CE} = -2.0$ V $I_{C} = -150$ mA, $V_{CE} = -2.0$ $I_{C} = -500$ mA, $V_{CE} = -2.0$ V	25 40 25	250	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -500mA, I _B = -50mA		-0.5	V
V _{BE} (on)	Base-Emitter On Voltage	I _C = -500mA, V _{CE} = -2.0V		-1.0	V

Thermal Characteristics T_{a=25°C} unless otherwise noted

Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation	1.0	W
	Derate above 25°C	8.0	mW/°C
R _{θJA}	Thermal Resistance, Junction to Ambient	125	°C/W

Device mounted on FR-4PCB 36mm x 18mm x 1.5mm; mounting pad for the collector lead min. 6cm².



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CROSSVOLT™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
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EcoSPARK™	HiSeC™	MSX™	Quiet Series™	TINYOPTO™
E ² CMOS™	I ² C™	MSXPro™	RapidConfigure™	TruTranslation™
EnSigna™	i-Lo™	OCX™	RapidConnect™	UHC™
FACT™	ImpliedDisconnect [™]	OCXPro™	µSerDes™	UltraFET [®]
FACT Quiet Series™		OPTOLOGIC [®]	SILENT SWITCHER [®]	VCX™
Across the board. Around the world.™		OPTOPLANAR™	SMART START™	
The Power Franchise [®]		PACMAN™	SPM™	
Programmable Active Droop™		POP™	Stealth™	

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